

CMXSH2-4LS

SURFACE MOUNT
DUAL PAIR, IN-SERIES
LOW V_F
SILICON SCHOTTKY DIODES



www.centralsemi.com

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMXSH2-LS consists of Dual, In-Series pairs of Low V_F Silicon Schottky Diodes, and is manufactured in a SUPERmini™ SOT-26 surface mount package. This device can be configured as a bridge rectifier using the optional mounting pad configuration on the following page.

MARKING CODE: CXS4L

SUPERmini™



**LOW
V_F**

SOT-26 CASE

MAXIMUM RATINGS: (T_A=25°C)

	SYMBOL		UNITS
Peak Repetitive Reverse Voltage	V _{RRM}	40	V
Continuous Forward Current	I _F	200	mA
Peak Repetitive Forward Current	I _{FRM}	350	mA
Peak Forward Surge Current, t _p =10ms	I _{FSM}	1.0	A
Power Dissipation	P _D	350	mW
Operating and Storage Junction Temperature	T _J , T _{stg}	-65 to +150	°C
Thermal Resistance	θ _{JA}	357	°C/W

ELECTRICAL CHARACTERISTICS PER DIODE: (T_A=25°C unless otherwise noted)

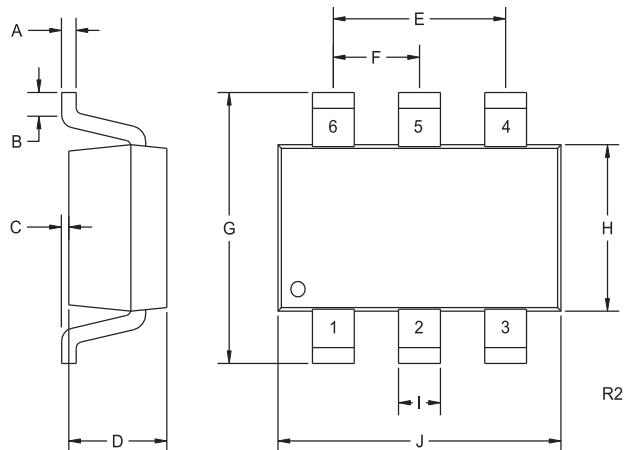
SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
I _R	V _R =20V		11	50	μA
BV _R	I _R =100μA	40	53		V
V _F	I _F =10mA		0.24	0.325	V
V _F	I _F =100mA		0.35	0.4	V
V _F	I _F =200mA		0.42	0.5	V
C _T	V _R =4.0V, f=1.0MHz		8.5	10	pF
t _{rr}	I _F =I _R =30mA, I _{rr} =3.0mA, R _L =100Ω		4.0	5.0	ns

CMXSH2-4LS

SURFACE MOUNT
DUAL PAIR, IN-SERIES
LOW V_F
SILICON SCHOTTKY DIODES



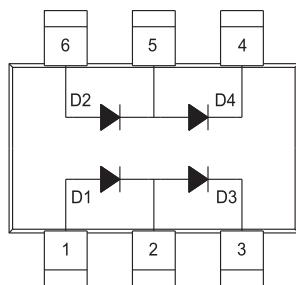
SOT 26 CASE - MECHANICAL OUTLINE



SYMBOL	DIMENSIONS			
	INCHES	MILLIMETERS	MIN	MAX
A	0.004	0.007	0.11	0.19
B	0.016	-	0.40	-
C	-	0.004	-	0.10
D	0.039	0.047	1.00	1.20
E	0.074	0.075	1.88	1.92
F	0.037	0.038	0.93	0.97
G	0.102	0.118	2.60	3.00
H	0.059	0.067	1.50	1.70
I	0.016	-	0.41	-
J	0.110	0.118	2.80	3.00

SOT-26 (REV: R2)

PIN CONFIGURATION

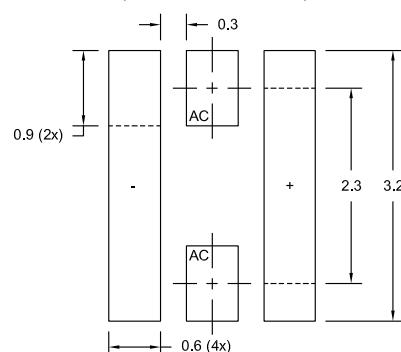


LEAD CODE:

- 1) Anode D1
- 2) Cathode D1, Anode D3
- 3) Cathode D3
- 4) Cathode D4
- 5) Anode D4, Cathode D2
- 6) Anode D2

MARKING CODE: CXS4L

OPTIONAL MOUNTING PADS
For Bridge Rectifier Configuration
(Dimensions in mm)



R2 (12-February 2010)